

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5347710

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
XIYUAN LIU	01/17/2019
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HASCO VISION TECHNOLOGY CO., LTD.
<b>Street Address:</b>	767 YECHENG ROAD, JIA DING
<b>City:</b>	SHANGHAI
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	201821
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16320737
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	6123343222
<b>Email:</b>	hstratton@wck.com
<b>Correspondent Name:</b>	JAMES L. YOUNG
<b>Address Line 1:</b>	900 SECOND AVENUE SOUTH
<b>Address Line 2:</b>	SUITE 1400
<b>Address Line 4:</b>	MINNEAPOLIS, MINNESOTA 55402
<b>ATTORNEY DOCKET NUMBER:</b>	H209.0001US1
<b>NAME OF SUBMITTER:</b>	JAMES L. YOUNG
<b>SIGNATURE:</b>	/James L. Young/
<b>DATE SIGNED:</b>	01/29/2019
<b>Total Attachments: 1</b>	
source=Signed Assignment#page1.tif	

# ASSIGNMENT

Attorney Docket No.

H209.0001US1

WHEREAS, I, Xiyuan LIU, am the inventor of an invention described in an application for Letters Patent of the United States entitled SURFACE LIGHT EMITTING MODULE FOR LED LIGHT SOURCE, VEHICLE LAMP USING THE SAME, AND METHOD OF ASSEMBLING THE SAME, the application having been executed on even date herewith, and/or being identifiable in the United States Patent and Trademark Office by Application No. 16/320,737, filed January 25, 2019; and

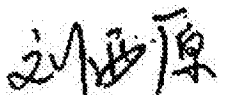
WHEREAS, HASCO VISION TECHNOLOGY CO., LTD. (hereinafter referred to as Assignee), a company organized and existing under the laws of the People's Republic of China, and having offices at 767 Yecheng Road, Jia Ding, Shanghai 201821, China ("Assignee") is desirous of acquiring the entire right, title and interest in and to the invention, the application, and any and all Letters Patent or similar legal protection, foreign or domestic, to be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, I transfer to Assignee, its successors and assigns, my entire right, title and interest in and to the invention, the above-identified application, corresponding domestic and foreign applications, all Letters Patent or similar legal protection issuing thereon, and all rights and benefits under any applicable treaty or convention; and I authorize the Director of the United States Patent and Trademark Office or foreign equivalent thereof to issue the Letters Patent or similar legal protection to the Assignee.

I authorize the Assignee, its successors and assigns, to insert in this instrument the filing date and serial number of the application when ascertained.

I authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent or similar legal protection, in its own name if desired, in any and all foreign countries.


I represent to the Assignee, its successors and assigns, that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I, my executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries.

  
\_\_\_\_\_  
Signature of Inventor (1)  
Date : 2019-1-17

LIU, Xiyuan  
\_\_\_\_\_  
Printed Name of Inventor

Residence of Inventor:  
767 Yecheng Road, Jia Ding  
Shanghai 201821, China

\_\_\_\_\_  
Citizenship: Chinese

  
\_\_\_\_\_  
Signature of Witness  
Date : 2019-1-17

CHEN, Hu  
\_\_\_\_\_  
Printed Name of Witness

Residence of Witness:  
767 Yecheng Road, Jia Ding,  
Shanghai 210821, China

\_\_\_\_\_  
Citizenship: \_\_\_\_\_